

Bumped GaAs SP3T Switch for WLAN 2.4 - 2.5 GHz

Features

- 802.11b/g and Bluetooth Applications
- Insertion Loss: 0.60 dB typical
- Isolation:

31 dB typical (R_X Path) 22 dB typical (T_X / BT paths)

- Flip-chip configuration
- RoHS* Compliant

Description

The MASW-008902-000DIE is a bumped single band GaAs pHEMT MMIC SP3T switch. Typical applications are for single band 2.4 GHz WLAN (802.11 b/g) and Bluetooth applications.

The MASW-008902-000DIE delivers high isolation, low insertion loss, and high linearity at 2.4 - 2.5 GHz.

The MASW-008902-000DIE is fabricated using a 0.5 micron gate length GaAs pHEMT process. The process features full passivation for performance and reliability. This die features SnAg (2.5%) solder bumps for WLCSP applications.

Ordering Information ^{1,2}

Commitment to produce in volume is not guaranteed.

Part Number	Package
MASW-008902-000DIE	Separated Die on Grip Ring
MASW-008902-000D3K	Die in 3000 piece reel
MASW-008902-001SMB	Sample Board SP3T

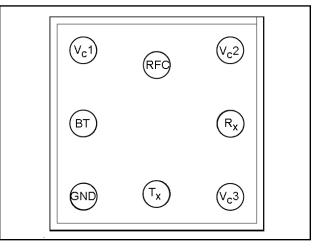
1. Die quantity varies.

1

2. Die on Grip Ring not available with orientation mark.

Rev. V4

Die Bump Pad Layout (bump side up)



Die Bump Pad Configuration

Name	Description		
V _c 1	Voltage Control 1		
ВТ	Blue Tooth T _x /R _x Port		
GND	Ground		
T _x	2.5 GHz T _x Port		
V _c 3	Voltage Control 3		
R _x	2.5 GHz R _x Port		
Vc2	Voltage Control 2		
RFC	Antenna Port		

Absolute Maximum Ratings ^{3,4}

Parameter	Absolute Maximum	
Input Power @ 3 V Control	+32 dBm	
Input Power @ 5 V Control	+35 dBm	
Operating Voltage	+8 volts	
Operating Temperature	-40°C to +85°C	
Storage Temperature	-65°C to +150°C	

3. Exceeding any one or combination of these limits may cause permanent damage to this device.

4. M/A-COM Technology does not recommend sustained operation near these survivability limits.

* Restrictions on Hazardous Substances, European Union Directive 2002/95/EC.

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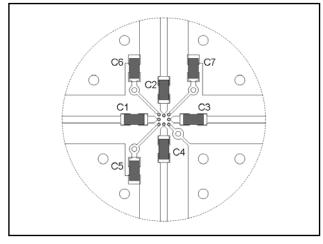
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Electrical Specifications⁵: $T_A = 25^{\circ}C$, $Z_0 = 50 \Omega$, $V_C = 0/3V$, $P_{IN} = 0 \text{ dBm}$

Parameter	Test Conditions		Min.	Тур.	Max.
Insertion Loss	RFC to $T_x/R_x/BT$, 2.4 GHz	RFC to T _x /R _x /BT, 2.4 GHz dB		0.60	0.75
Isolation	RFC to T _x , 2.4 GHz RFC to R _x , 2.4 GHz RFC to BT, 2.4 GHz	dB	20 30 20	23.5 31.0 21.0	
Return Loss	2.4 - 2.5 GHz	dB	_	15	
IP3	RF to $T_x/R_x/BT$, 2.4 GHz, 20 dBm Total Power, 1 MHz Spacing	dBm	—	55	_
Input P1dB	RF to T _x , 2.4 - 2.5 GHz RF to R _x , 2.4 - 2.5 GHz RF to BT, 2.4 - 2.5 GHz	dBm		32 28 32	
Harmonics	RF to T _x , 2.4 - 2.5 GHz, 20 dBm	dBm		-75	
Switching Speed	50% control to 90% RF 50% control to 10% RF	ns		165 25	
Control Current	V _c = 3 V	μA	—	<1	10

5. External blocking capacitors on all RF ports.

Recommended PCB Configuration



Parts List

Part	Value	Case Style
C1 - C4	39 pF	0402
C5 - C7	1000 pF	0402

Truth Table 6,7,8

V _c 1	V _c 2	V _c 3	RFC-BT	RFC-T _x	RFC-R _x
1	0	0	On	Off	Off
0	1	0	Off	On	Off
0	0	1	Off	Off	On

6. For positive voltage control, external DC blocking capacitors are required on all RF ports.

- Differential voltage, V(state 1) V(state 0), must be +2.7 V minimum and must not exceed +5 V.
- 8. $0 = 0 \pm 0.3$ V, 1 = +2.7 V to +5 V.

Handling Procedures

Please observe the following precautions to avoid damage:

Static Sensitivity

Gallium Arsenide Integrated Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices.

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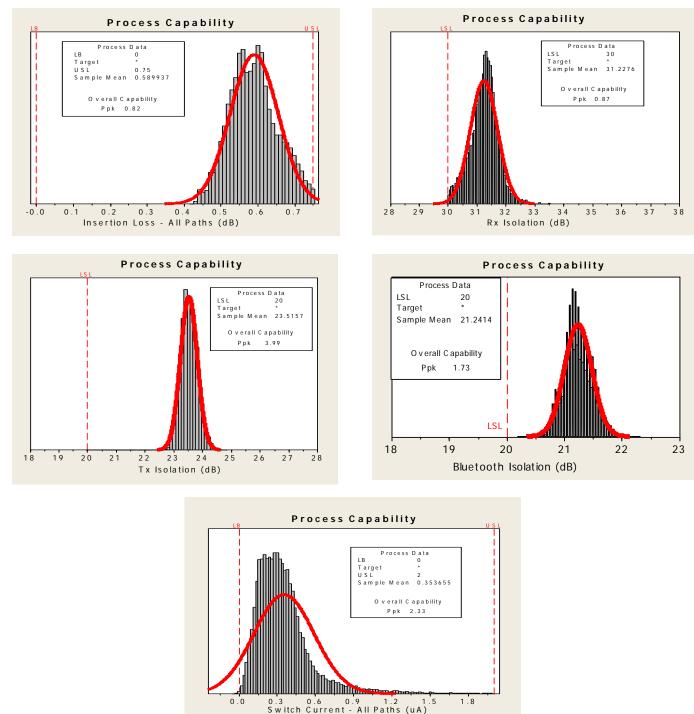
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Rev. V4

Product Consistency Distribution Charts⁹ (on wafer RF test)



- 9. Represents >50 wafers, tested per electrical specifications: Freq. = 2.4 GHz, $T_A = 25^{\circ}C$, $Z_0 = 50 \Omega$, $V_C = 0/3V$, $P_{IN} = 0 dBm$
- 3

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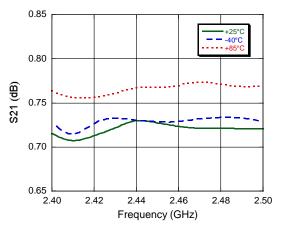
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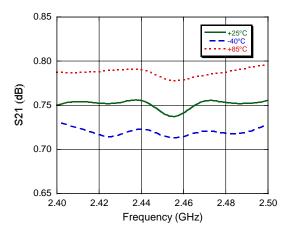
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Typical Performance Curves (plots = chip on board assembly)

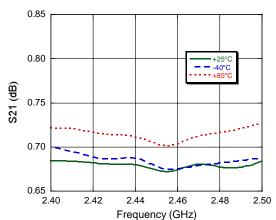
T_x Insertion Loss

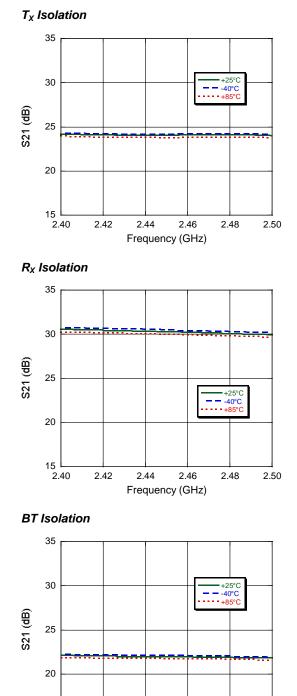


R_x Insertion Loss



BT Insertion Loss







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Frequency (GHz)

2.46

2.48

2.50

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2.44

15

2.40

2.42

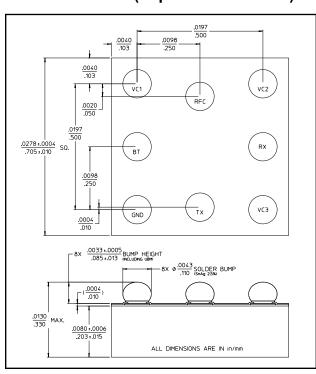
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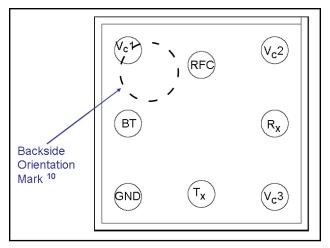
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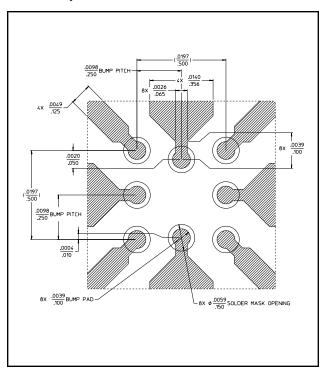
Die Dimensions (Top and Side Views)



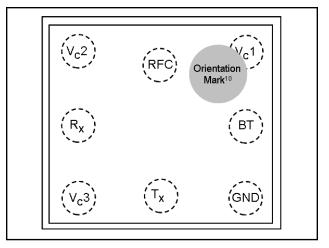
Die Bump Pad Layout - Top View (bump side up)



PCB Top Metal / Solder Mask



Die Bump Pad Layout - Bottom View (bump side down - as installed on board)



10.Orientation mark is only on material that is shipped in tape and reel. The mark is not available on die shipped on grip ring.

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5

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